

QL24x32BL
pASIC® 1 Family
Low Power 3.3 Volt Operation FPGA

**pASIC
HIGHLIGHTS**

*...8000
usable ASIC gates,
180 I/O pins*

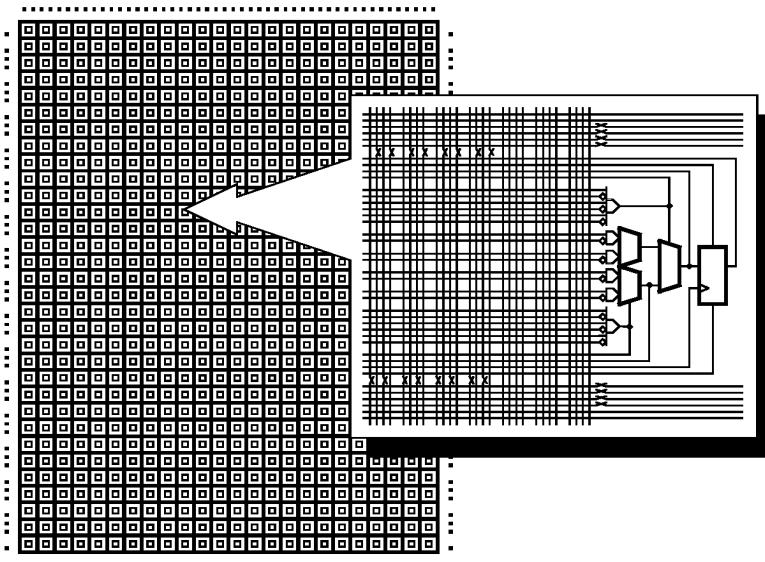
- ☒ **High Speed** – ViaLink® metal-to-metal programmable-via antifuse technology, allows counter speeds over 80 MHz at 3.3 Volt operation.
- ☒ **5V Tolerant I/Os** – Support interface to 5 Volt CMOS, NMOS and bipolar devices by sinking up to 12 mA (see IIH specification).
- ☒ **High Usable Density** – A 24-by-32 array of 768 logic cells provides 8,000 usable ASIC gates (14,000 PLD gates) in 144-pin TQFP and 208-pin PQFP packages.
- ☒ **Compatible with Standard 5.0V product** – The "-L" series is fully pin-out and function compatible with the High Speed 5.0V product. See QL24x32B for pin-out and AC Characteristics.
- ☒ **Low-Cost, Easy-to-Use Design Tools** – Designs entered and simulated using QuickLogic's new QuickWorks® development environment, or with third-party CAE tools including Viewlogic, Synopsys, Mentor, Cadence and Veribest. Fast, fully automatic place and route on PC and workstation platforms using QuickLogic software.

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**QL24x32BL
Block Diagram**

768 Logic Cells



- = Up to 172 prog. I/O cells, 6 Input high-drive cells, 2 Input/Clk (high-drive) cells



**QL24x32BL****ABSOLUTE MAXIMUM RATINGS**

Supply Voltage	-0.5 to 7.0V	Storage Temperature	-65°C to + 150°C
Input Voltage	-0.5 to VCC +0.7V	Lead Temperature	300°C
ESD Pad Protection.....	±2000V		
DC Input Current.....	±20 mA		
Latch-up Immunity.....	±200 mA		

OPERATING RANGE

Symbol	Parameter	Commercial		Unit
		Min	Max	
VCC	Supply Voltage	3.0	3.6	V
TA	Ambient Temperature	0	70	°C
TC	Case Temperature			°C
K	Delay Factor	0.46	2.61	
	-0 Speed Grade	0.46	2.23	
	-1 Speed Grade			

DC CHARACTERISTICS over operating range

Symbol	Parameter	Conditions	Min	Max	Unit
VIH	Input HIGH Voltage		2.0		V
VIL	Input LOW Voltage			0.8	V
VOH	Output HIGH Voltage	IOH = -2.4 mA	2.4		V
		IOH = -10 mA	VCC-0.1		V
VOL	Output LOW Voltage	IOL = 4 mA		0.4	V
		IOL = 10 μA		0.1	V
IIH	Input HIGH Current Sink (for tolerance to 5V devices)	VCC+0.6V > VI > VCC		12	mA
II	Input Leakage Current	VI = VCC or GND	-10	10	μA
IOZ	3-State Output Leakage Current	VI = VCC or GND	-10	10	μA
CI	Input Capacitance [1]			10	pF
IOS	Output Short Circuit Current [2]	VO = GND	-5	-50	mA
		VO = VCC	15	100	mA
ICC	Supply Current [3]	VI, VIO = VCC or GND		650	μA

Notes:

- [1] Capacitance is sample tested only. CI = 20 pF max on I/(SI) and I/(P).
- [2] Only one output at a time. Duration should not exceed 30 seconds.
- [3] For AC conditions use the formula described in the Data Book, Section 9 — Power vs Operating Frequency.

ORDERING INFORMATION